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**OLIFF & BERRIDGE, PLC**

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ATTORNEYS AT LAW**Application Data Sheet****Applicant Information**

Applicant Authority type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Hiroji
Family Name::	AGA
City of Residence::	Annaka-shi
Country of Residence::	Japan

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Applicant Authority Type::	Inventor
Primary Citizenship Country::	Japan
Status::	Full Capacity
Given Name::	Kiyoshi
Family Name::	MITANI
City of Residence::	Annaka-shi
Country of Residence::	Japan

**Correspondence Information**

Correspondence Customer Number::	25944
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**Application Information**

Application Type::	National Phase
Subject Matter::	Utility
CD-ROM or CD-R::	None
Title::	METHOD OF FABRICATING SOI WAFER
Attorney Docket Number::	121797
Suggested Drawing Figure::	1
Total Drawing Sheets::	8
Small Entity::	No

**Representative Information**

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<b>Domestic Priority Information</b>			
Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application is a	National Stage of	PCT/JP03/09007	07/16/03
<b>Foreign Priority Information</b>			
Country::	Application Number::	Filing Date::	Priority Claimed::
Japan	2002-219308	07/29/02	Yes
<b>Assignee Information</b>			
Assignee Name::		Shin-Etsu Handotai Co., Ltd.	
Street of mailing address::		4-2, Marunouchi 1-chome, Chiyoda-ku	
City of mailing address::		Tokyo	
Country of mailing address::		Japan	
Postal or Zip Code of mailing address::		100-0005	